# RAYSTAR

# SPECIFICATION

Page 1, Total 28 Pages



# **OLED SPECIFICATION**

Model No:

# REX012864LWAP3N00000

**CUSTOMER:** 

APPROVED BY	,		
PCB VERSION			
DATE			
FOR CUSTOMER USE	ONLY	562	
SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
			1000-00

APPROVAL FOR SPECIFICATIONS ONLY

**\_APPROVAL FOR SPECIFICATIONS AND SAMPLE** 



# 1. Revision History

VERSION	DATE	REVISED PAGE NO.	Note
0	2016/02/25		First release
A	2016/06/01		Modify Static
			electricity test
В	2016/12/07		Modify Interface
С	2018/02/05		Modify Reliability test
			Condition
D	2018/11/27		Modify Static
			electricity test
			Content of Test



# Contents

- 1. General Specification
- 2.Module Classification Information
- 3.Interface Pin Function
- 4.Contour Drawing & Block Diagram
- 5. Absolute Maximum Ratings
- **6.**Electrical Characteristics
- 7.Optical Characteristics
- 8.OLED Lifetime
- 9.Reliability
- 10.Inspection specification
- 11.Precautions in use of OLED Modules



## **1.General Specification**

The Features is described as follow:

- Module dimension: 34.50 × 23.00 × 1.65 mm
- Active area: 29.42 × 14.20 mm
- Dot Matrix: 128\*64
- Pixel size: 0.205 × 0.197 mm
- Pixel pitch: 0.230 × 0.222 mm
- Duty: 1/64 Duty
- Display Mode : Passive Matrix
- Display Color: White
- IC: SH1106G
- Interface: 6800/8080/3-SPI /4-SPI / I2C
- Size: 1.28inch



## **2.Module Classification information**

1	2	3	4	5	6	7	8	9	10	11	12	13	14
R	E	Х	012864	L	W	А	Р	3	Ν	0	0	0	00

1	Brand : Raysta	ar Op	tronics Inc.			
2	E : OLED					
3	Display Type	X :	COB Character COG COG + FR + PCB			COB Graphic COG + FR AB
			COG + PCB			
4		28*6	4			
5	Series					
			A : Amber	R : Red		C : Full Color
6	Emitting Color		B : Blue	W : White		
0	Emitting Color		G : Green	Y : Yellow		
			S : Sky Blue	X : Dual Color		
7	Polarizer		P: With Polarizer;		izer	
			A : Anti-glare Pola		_	
8	Display Mode	9	P : Passive Matrix		ïх	
9	Driver Voltage		3:3.0~3.3V ; 5		5	
10	Touch Panel		N: Without touch p	panel; T: With tou	ich par	nel
	Product type		0 : Standard 1 : Daylight Reada			0000
11	T Toddet type	$\checkmark$	2 : Transparent OL	· · · ·		
			3 : Flexible OLED 4 : OLED Lighting	(FOLED)		
			0 : Standard			
			2 : B grade			
12	Inspection Gra	de	C : Automotive gra	ide		
			Y : Consumer grad			
13	Option		0 : Default ; F : ZIF		oar FP	C; D : Demo Kit
14	Serial No.		Serial number(00~2	ZZ)		1000000



## **3. Interface Pin Function**

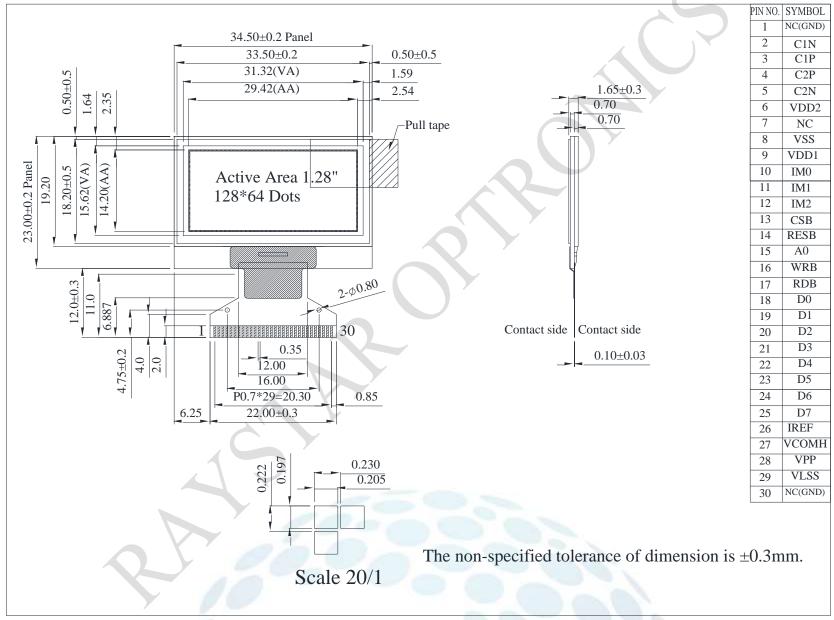
No.	Symbol	Function						
1	NC(GND)	No conne	ection					
2	C1N		0 1	mp capacito				
3	C1P	These pirexternally		ed and shou	ld be discor	nnected when	Vpp is supp	lied
4	C2P	Connect	to charge pu	mp capacito	r.			
-	001			ed and shou	ld be discor	nnected when	Vpp is supp	lied
5	C2N	externally						
6	VDD2		•			/ for charge p		
7	NC	No conne	ection					
8	VSS	Ground.						
9	VDD1	Power su	pply input: 1	.65 - 3.5V				
10	IM0	These ar	e the MPU ir	nterface mod	e select pac	ds.		
10			8080	I <sup>2</sup> C	6800	4-wire SPI	3-wire SPI	
11	IM1	IM0	0	0	0	0	1	
		IM1	1	1	0	0	0	
12	IM2	IM2	1	0	1	0	0	
13	CSB	active,		elect input. V O is enabled		"L", then the	chip select b	ecomes
14	RESB	initialized	. The reset	input pad. W d by the RES		set to "L", the	e settings are	
15	A0	This is th data or a command A0 = "H": A0 = "L":	e Data/Comi d. the inputs a the inputs at erface, this p	mand control t D0 to D7 ar : D0 to D7 ar	pad that de e treated as e transferre	etermines whe s display data d to the comn stinguish the c	nand register	·S.
16	WRB	When co 8080 MP signal. Th signal. When co terminal. When R/	nnected to a U WR ne signals or	the data bu 6800 Series ad.	, this is activ s are latche	ve LOW. This d at the rising is the read/w	edge of the	WR



17	RDB	This is a MPU interface input pad. When connected to an 8080 series MPU, it is active LOW. This pad is connected to the RD signal of the 8080 series MPU, and the data bus is in an output status when this signal is "L". When connected to a 6800 series MPU , this is active HIGH. This is used as an enable clock input of the 6800 series MPU. When RD = "H": Enable. When RD = "L": Disable.
18	D0	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard
19	D1	MPU data bus.
20	D2	When the serial interface is selected, then D0 serves as the serial clock input pad
21	D3	(SCL) and D1
22	D4	serves as the serial data input pad (SI). At this time, D2 to D7 are set to high
23	D5	impedance.
24	D6	When the I2C interface is selected, then D0 serves as the serial clock input pad (SCL) and D1
25	D7	serves as the serial data input pad (SDAI). At this time, D2 to D7 are set to high impedance.
26	IREF	This is a segment current reference pad. A resistor should be connected between this pad and VSS. Set the current at 18.75uA.
27	VCOMH	This is a pad for the voltage output high level for common signals. A capacitor should be connected between this pad and VSS.
28	VPP	OLED panel power supply. Generated by internal charge pump. Connect to capacitor. It could be supplied externally.
29	VLSS	This is a segment voltage reference pad. This pad should be connected to VSS externally.
30	NC(GND)	No connection

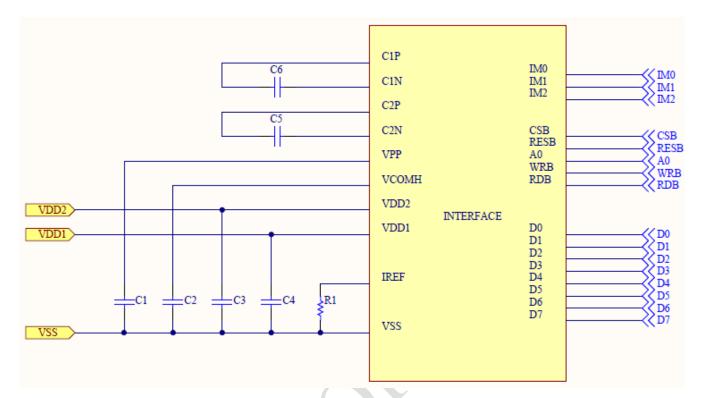








#### 4.1 Application recommendations



Recommended components :

C1, C2: 0.22uF

C3, C4, C5, C6 : 4.7uF

Bus Interface selection: (Must be set the IM[2:0], refer to item 4) 8-bits 6800 and 8080 parallel, 3 or 4-wire SPI, I2C

R1: about 310k (ISEG=300uA), R1 = (Voltage at IREF - VSS)/IREF

\*For more information, please refer to Application Note provided by Raystar Optronics.





## **5.Absolute Maximum Ratings**

Parameter	Symbol	Min	Max	Unit
Supply Voltage for Logic	VDD1	-0.3	3.6	V
Power supply for charge pump circuit	VDD2	-0.3	4.8	V
Supply Voltage for Display	VPP	-0.3	14.5	V
Operating Temperature	ТОР	-40	+80	°C
Storage Temperature	TSTG	-40	+85	°C



### **6.Electrical Characteristics**

### 6.1 DC Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Мах	Unit
Supply Voltage for Logic	VDD		2.8	3.0	3.3	V
Supply Voltage for Display	VCC	_	6.75	7.25	7.75	V
High Level Input	VIH	_	0.8xVDD	- /	VDD	V
Low Level Input	VIL	_	VSS		0.2xVDD	V
High Level Output	VOH	_	0.8xVDD		VDD	V
Low Level Input	VOL	_	VSS	Ì	0.2xVDD	V
50% Check Board operating	Current	VCC =7.25V	5.0	6.0	7.0	mA

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}

#### 6.2 Initial code

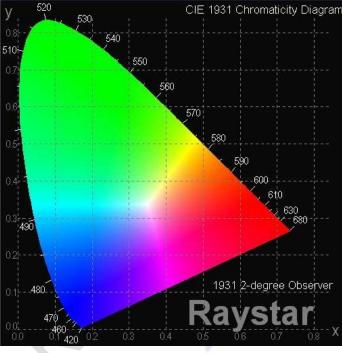
void INIT\_SH1106G(){

WriteCommand(0xB0); WriteCommand(0x10); WriteCommand(0x00);	//set page address //set higher column address //set lower column address
WriteCommand(0xA4);	//set entire display off
WriteCommand(0xD5); WriteCommand(0x50);	//set display clock dievid ratio/osc frequency
WriteCommand(0xA8); WriteCommand(0x3F);	//buguan //3F
WriteCommand(0xD3); WriteCommand(0x00);	//display offset,set to 0x00
WriteCommand(0x40);	//set start line,set to 0x40
WriteCommand(0xAD); WriteCommand(0x8B);	//set DC-DC ON // 8B: ON ; 8A: OFF
WriteCommand(0x31);	//VPP SET 7.4V
WriteCommand(0xA1);	//set segment re-map,SEG131~S0
WriteCommand(0xc8);	//set commom output scan direction;
WriteCommand(0xDa); WriteCommand(0x12);	//common pad configuration
WriteCommand(0x81); WriteCommand(0xff);	//set contrast
WriteCommand(0xD9); WriteCommand(0x11);	//set dis-charge/pre-charge period
WriteCommand(0xDB); WriteCommand(0x35);	//set VCOM deselect level
WriteCommand(0xA6);	//set normal display
WriteCommand(0xAF);	//display on



## **7.Optical Characteristics**

Item	Symbol	Condition	Min	Тур	Мах	Unit
	(V)θ	_	160		-	deg
View Angle	(H)φ	_	160			deg
Contrast Ratio	CR	Dark	2000:1	-	—	_
Deenenee Time	T rise	_	—	10		μs
Response Time	T fall		_	10	_	μs
Display with 50% check E	Board Brightness		60	80	_	cd/m2
CIEx(White	e)	(CIE1931)	0.26	0.28	0.30	—
CIEy(White	e)	(CIE1931)	0.30	0.32	0.34	—





#### 8.OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25°C / Initial 50% check board brightness Typical Value	20,000 Hrs	-	Note

Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.



## 9.Reliability

#### Content of Reliability Test

Test Item	Content of Test	Test Condition	Applicable Standard	
High Temperature storage	Endurance test applying the high storage temperature for a long time.	85°C 240hrs	- (	
₋ow Temperature storage	Endurance test applying the low storage temperature for a long time.	-40°C 240hrs	-	
ligh ēmperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80°C 240hrs	-	
₋ow ſemperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40°C 240hrs		
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C,90%RH 240hrs		
High Temperature/ Humidity Operation	Endurance test applying the high temperature and high humidity Operation for a long time.	60°C,90%RH 120hrs		
Femperature Cycle	Endurance test applying the low and high temperature cycle. -40°C 25°C 80°C 30min <u>5min 30min</u>	-40°C /80°C 30 cycles	100	
Mechanical Te	st	0-		
/ibration test	Endurance test applying the vibration during transportation and using.	Frequency:10~55Hz amplitude:1.5mm Time:0.5hrs/axis Test axis:X,Y,Z	-2	
Others	7			
Static electricity test	Endurance test applying the electric stress to the finished product housing.	Air Discharge model ±4kv,10 times	_	

\*\*\* Supply voltage for OLED system =Operating voltage at 25°C



#### Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

#### **Evaluation criteria**

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

#### **APPENDIX:**

#### **RESIDUE IMAGE**

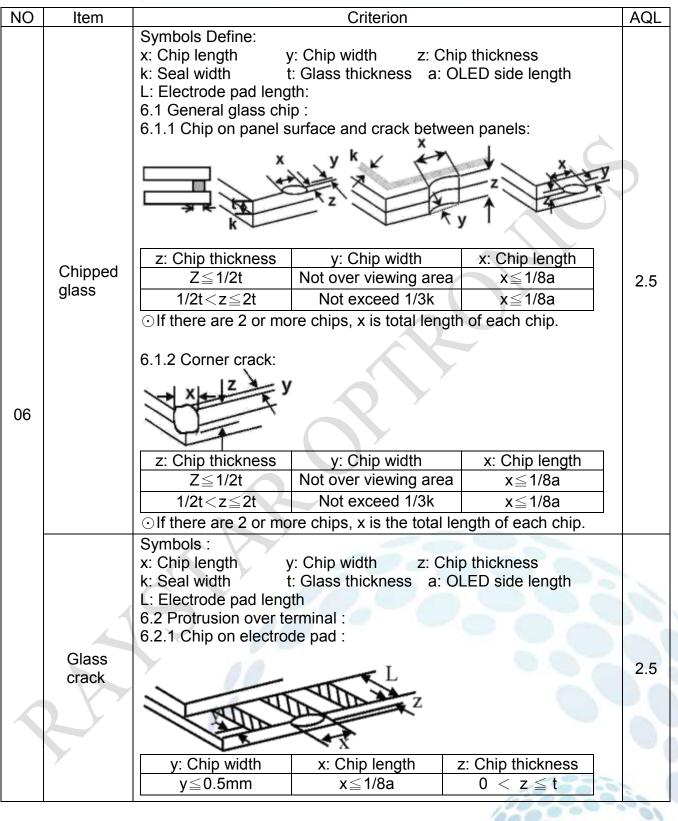
Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.



## **10.Inspection specification**

NO	Item	Criterion			AQL	
01	Electrical Testing	<ul> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 OLED viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Contrast defect.</li> </ul>			0.65	
02	Black or white spots on OLED (display only)	<ul> <li>2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.</li> <li>2.2 Densely spaced: No more than two spots or lines within 3mm.</li> </ul>			2.5	
03	OLED black spots, white spots, contamin ation (non- display)	3.1 Round type : As following drawin $\Phi = (x + y) / 2$		$SIZE \Phi \le 0.10 0.10 < \Phi \le 0.20 0.20 < \Phi \le 0.25 0.25 < \Phi$	Acceptable QTY Accept no dense 2 1 0	2.5
		3.2 Line type : (As following drawing)				
			Length	Width	Acceptable Q TY	
		∽ /Iw		W≦0.02	Accept no dense	
			L≦3.0	$0.02 < W \le 0.03$		2.5
		L. A.	L≦2.5	$0.03 < W \le 0.05$	2	
				0.05 <w< td=""><td>As round type</td><td></td></w<>	As round type	
		If bubbles are visible, judge using black spot specifications, not easy to		Size Φ	Acceptable Q TY	
				Ф≦0.20	Accept no dense	
04	Polarizer			$0.20 < \Phi \le 0.50$	3	2.5
	bubbles find, must check in s direction.		specity	$0.50 < \Phi \le 1.00$	2	
				1.00<Φ	0	
				Total Q TY	3	
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination.			00	
L	I	100000				







NO	Item	Criterion	AQL
06	Glass crack	6.2.2 Non-conductive portion: $i$ $j$ $k$ $j$ $j$ $j$ $j$ $j$ $j$ $j$ $k$ $j$ $j$ $j$ $j$ $j$ $j$ $j$ $k$ $k$ $j$ $k$	2.5
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Backlight elements	<ul> <li>8.1 Illumination source flickers when lit.</li> <li>8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards.</li> <li>8.3 Backlight doesn't light or color wrong.</li> </ul>	
09	Bezel	<ul><li>9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.</li><li>9.2 Bezel must comply with job specifications.</li></ul>	

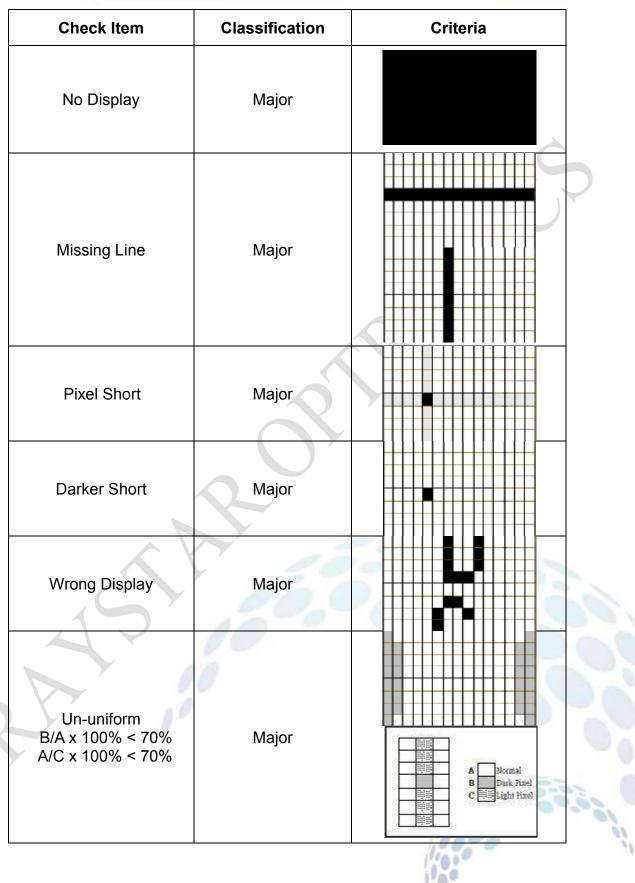


NO	Item	Criterion	
		10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	2.5
		10.2 COB seal surface may not have pinholes through to the	2.5
		IC.	0.65
		10.3 The height of the COB should not exceed the height indicated in the assembly diagram.	2.5
	PCB , COB	10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than	2.5
10		three places.	2.5
		10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production	0.65
		characteristic chart. There should be no wrong parts,	0.65
		missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product	0.65
		characteristic chart.	2.5
		10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or	
		screw hold pad, make sure it is smoothed down.	
		11.1 No un-melted solder paste may be present on the PCB.	2.5
	Soldering	11.2 No cold solder joints, missing solder connections,	2.5
11		oxidation or icicle.	0.5
		<ul><li>11.3 No residue or solder balls on PCB.</li><li>11.4 No short circuits in components on PCB.</li></ul>	2.5 0.65
			0.00
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
	General	12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin	2.5
12	appearance	to sever. 12.6 The residual rosin or tin oil of soldering (component or	2.5
		chip component) is not burned into brown or black color.	2.0
		12.7 Sealant on top of the ITO circuit has not hardened.	2.5
	7	12.8 Pin type must match type in specification sheet.	0.65
		12.9 OLED pin loose or missing pins. 12.10 Product packaging must the same as specified on	0.65
		packaging specification sheet.	6
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	



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## **11.Precautions in use of OLED Modules**

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- (3) Don't disassemble the OLED display module.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist OLED display module.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) It's pretty common to use "Screen Saver" to extend the lifetime and Don't use fix information for long time in real application.
- (9) Don't use fixed information in OLED panel for long time, that will extend "screen burn" effect time.
- (10) Raystar has the right to change the passive components, including R2and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)

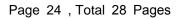
(11) Raystar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Raystar have the right to modify the version.)

#### **11.1 Handling Precautions**

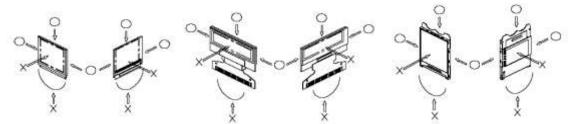
- (1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
- \* Scotch Mending Tape No. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent Also, pay attention that the following liquid and solvent may spoil the polarizer:

- \* Water
- \* Ketone
- \* Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.







- (7) Do not apply stress to the LSI chips and the surrounding molded sections.
- (8) Do not disassemble nor modify the OLED display module.
- (9) Do not apply input signals while the logic power is off.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
- \* Be sure to make human body grounding when handling OLED display modules.
- \* Be sure to ground tools to use or assembly such as soldering irons.
- \* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- \* Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.
- (11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

#### **11.2 Storage Precautions**

- (1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. And, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments.(We recommend you to store these modules in the packaged state when they were shipped from Raystar Optronics Inc. At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- (2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.



#### **11.3 Designing Precautions**

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) When fastening the OLED display module, fasten the external plastic housing section.
- (7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module. Connection (contact) to any other potential than the above may lead to rupture of the IC.
- (8) The limitation of FPC and Film bending.

Display area	Min 2mm		
		5mm	
15	100		



		Page: 1			
Module Sample Estimate Feedback Sheet					
Module Number :					
<b>1</b> <u>►</u> <u>Panel Specification</u> :					
1. Panel Type:	Pass	□NG ,			
2. Numbers of Pixel :	Pass	□NG ,			
3. View Area :	Pass	□NG ,			
4. Active Area:	Pass	□NG ,			
5.Emitting Color :	Pass	□NG ,			
6.Uniformity :	□Pass	□NG ,			
7.Operating	Pass	□NG ,			
Temperature :		· · · · · · · · · · · · · · · · · · ·			
8.Storage	Pass	□NG ,			
Temperature :					
9.Others :					
2 · <u>Mechanical Specificati</u>	1				
1. PCB Size :	□Pass	□NG ,			
2.Frame Size :	□Pass	□NG ,			
3.Materal of Frame :	□Pass	□NG ,			
4.Connector Position :	□Pass	□NG ,			
5.Fix Hole Position :	□Pass	□NG ,			
6. Thickness of PCB :	□Pass	□NG ,			
7. Height of Frame to	□Pass	□NG ,			
PCB :		10000			
8.Height of Module :	□Pass	□NG ,			
9.Others :	□Pass	□NG ,			
3 · <u>Relative Hole Size</u> :	3 · <u>Relative Hole Size</u> :				
1.Pitch of Connector :	□Pass	□NG ,			
2.Hole size of	□Pass	□NG ,			
Connector :	10				
3.Mounting Hole size :	□Pass	□NG ,			
4.Mounting Hole Type :	□Pass	□NG ,			
5.Others :	□Pass	□NG ,			
>> Go to page 2 <<					



Page: 2

Module Number :		raye.
4 · Electronic Characteristi	ics of Modu	
1.Input Voltage :	□Pass	□NG ,
2.Supply Current :	□Pass	□NG ,
3.Driving Voltage for OLED :	□Pass	□NG ,
4.Contrast for OLED :	□Pass	□NG ,
5.Negative Voltage	□Pass	□NG ,
Output :		
6.Interface Function :	□Pass	□NG ,
7.ESD test :	□Pass	□NG ,
8.Others :	□Pass	□NG ,
Sales signature :	R	
Customer Signature	e:	Date : / /
	e:	<u>Date : / /</u>